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Introducing (HSR) Connector

High Speed Ruggedized High Performance Backplane Connector System



High Speed Ruggedized Connector





DESCRIPTION

High Speed Ruggedized (HSR) is a high speed, high power and rugged aerospace and defense LRU/LRM board connector system.

APPLICATIONS

Ground base stations and communications systems

Central computing, satellite on-board and ship-board computing

Land and sea anti-ballistic signal processing

Heads-up avionics

Ground sensor

Unmanned central

processing

Electronic countermeasure

Power distribution systems

KEY FEATURES

Shock and vibration per VITA 47

Temperature range: -65°C to +125°C

Durability:

500 cycles

| Common insert/shell geometry enables multiple configurations | | |
|---|--|--|
| High performance up to 10 Gb/s - High power contact 15 A/contact | | |
| Rugged metal shell with integral guidance hardware | | |
| Configurations: - 120 pair differential pairs max./connector - 240 open field signal contacts max./connector - 32 SMPM RF connectors max./connector - 32 position power contacts max./connector | | |
| Hybrids available - Mix multiple inserts:- 30 pair differential module- 60 open pin field module- 8 power contacts module- 8 position RF coax module- Optics- 8 position RF coax module | | |
| Vertical and right-angle press fit | | |
| Dual beam contact design | | |
| Replaceable signal pins (backplane connector only) | | |
| Panel mount available | | |
| Easy mate/unmate with provided guiding hardware and keying | | |
| Level II maintenance ESD protection for signal modules | | |
| Card pitch .9" | | |
| Board-to-board and flex-to-board available | | |
| MATERIALS | | |
| | | |

| Shell: | Aluminum, electroless nickel plate | |
|-------------------------|--|--|
| | | |
| Housing: | Glass filled polyester, 94V-0 rated or LCP | |
| Contact material: | Copper Alloy | |
| | | |
| Contact area finish: | 1.2 μm Au min. over 1.3 μm Ni min. | |
| Concellant wire finisks | | |
| Compliant pin finish: | .8 μm Sn/Pb. or matte tin min. over 1.3 μm Ni min. | |
| | | |
| MECHANICAL | | |
| | | |

| Mother board connector | • |
|------------------------|---|
| Part Number 2000668-1 | l |

Daughter card connector

Part Number 2000667-1

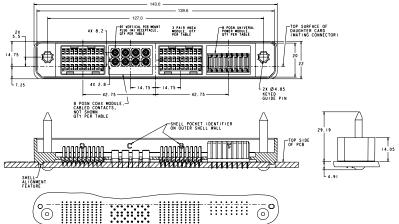


RF Cable assemblies available with SMPM, SMP, OSP, OSSP, SMA, MCX and more....

ESD protection: Insulation resist

Dielectric withst

Current:



Dimensions shown for reference purposes only. Specifications subject to change.

High Speed Ruggedized Connector

ELECTRICAL CHARACTERISTICS

| Differential Pair: High Speed Differential Applications up to 10 Gb/s Data Rates: | | |
|--|---|--|
| Differential impedance: | 100 Ω ± 10% with 50 ps risetime (20-80%) pulse | |
| Crosstalk: | Full density multiple aggressors | |
| NEN <3% with 100 ps risetime pulse, FEN <3% with 100 ps risetime pulse | | |
| Insertion loss: | <1 dB @ 3 GHz | |
| Open field signal contact: | Single end impedance 50 Ω | |
| RF Coax SMPM connector: | Impedance: 50 ohms Insertion Loss: IL = .12 dB max. SVWR = 1.5 Max. @ 6 GHz | |
| ESD protection: | Max. ESD voltage ±26 kV | |
| Insulation resistance: | 1000 megohms | |
| Dielectric withstanding voltage: | 650 VAC | |
| Ratings: | | |
| Current: | 15 A/contact for power contacts 0.7 A/contact for signal contacts | |
| Operating Voltage: | 250 VAC maximum, signal or power to ground | |
| 3 7 15.75 15.75 Shell Pudat Lidentifier 127.0 | | |

